



1N4001 THRU 1N4007

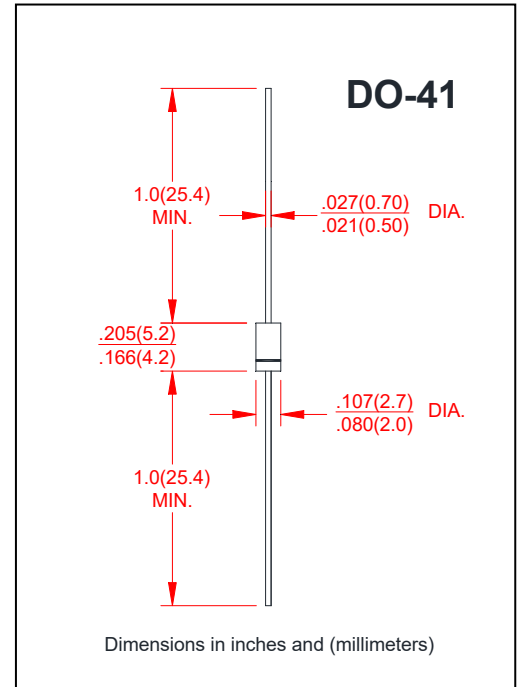
VOLTAGE RANGE 50 to 1000 Volts
CURRENT 1.0 Ampere

Features

- OJ chip junction
- Low forward voltage drop
- Low leakage current
- High forward surge capability
- High reliability
- High temperature soldering guaranteed
 260°C/10 seconds, 0.375"(9.5mm) lead length at 5 lbs(2.3kg) tension

Mechanical Data

- Case: Transfer molded plastic
- Epoxy: UL94V-0 rate flame retardant
- Polarity: Color band denotes cathode end
- Lead: Plated axial lead, solderable per MIL-STD-202E method 208C
- Mounting position: Any
- Weight: 0.012ounce, 0.33 grams



Maximum Ratings and Electrical Characteristics

- Ratings at 25°C ambient temperature unless otherwise specified
- Single Phase, half wave, 60Hz, resistive or inductive load
- For capacitive load derate current by 20%

TYPE NUMBER	SYMBOL	1N 4001	1N 4002	1N 4003	1N 4004	1N 4005	1N 4006	1N 4007	UNIT
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	50	100	200	400	600	800	1000	Volts
Maximum RMS Voltage	V_{RMS}	35	70	140	280	420	560	700	Volts
Maximum DC Blocking Voltage	V_{DC}	50	100	200	400	600	800	1000	Volts
Maximum Average Forward Rectified Current (FIG. 1) 0.375"(9.5mm) lead length at $T_A=75^\circ\text{C}$	$I_{(AV)}$	1.0							Amp
Peak Forward Surge Current 8.3ms single half sine wave superimposed on rated load (JEDEC method)	I_{FSM}	30							Amps
Maximum Instantaneous Forward Voltage at 1.0A	V_F	1.1							Volts
Maximum DC Reverse Current at Rated DC Blocking Voltage at	$T_A = 25^\circ\text{C}$	5.0							μA
	$T_A = 125^\circ\text{C}$	50							
Maximum Full Load Reverse Current, full cycle Average 0.375(9.5mm) lead length at $T_L=75^\circ\text{C}$	$I_{R(AV)}$	30							μA
Typical Junction Capacitance (NOTE 1)	C_J	15							pF
Typical Thermal Resistance (NOTE 2)	$R_{\theta JA}$	50							$^\circ\text{C}/\text{W}$
Operating and Storage Temperature Range	T_J, T_{STG}	-55 to +150							$^\circ\text{C}$

Notes:

1. Measured at 1.0MHz and applied reverse voltage of 4.0 Volts.
2. Thermal Resistance HERom Junction to Ambient at .375"(9.5mm) lead length, P.C. board mounted.



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Ratings and Characteristic Curves ($T_A=25^\circ\text{C}$ unless otherwise noted)

FIG.1-TYPICAL FORWARD CURRENT DERATING CURVE

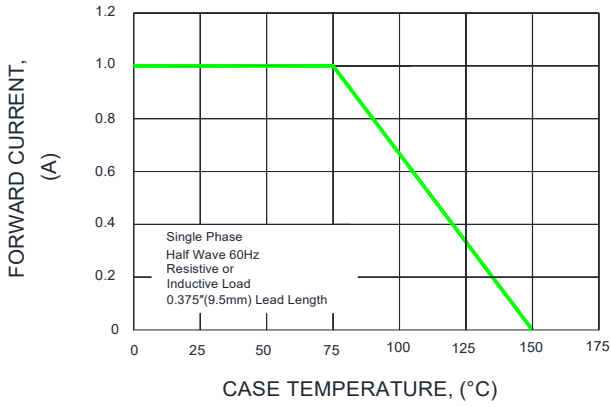


FIG.2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

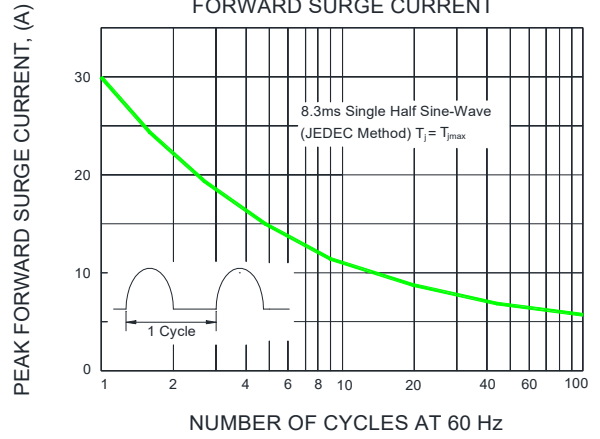


FIG.3-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

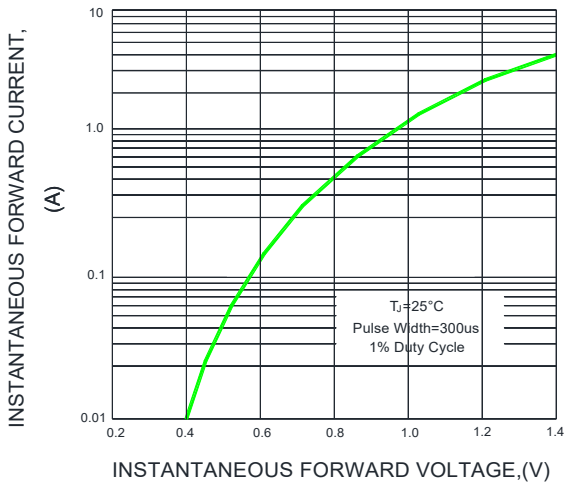


FIG.4-TYPICAL REVERSE CHARACTERISTICS

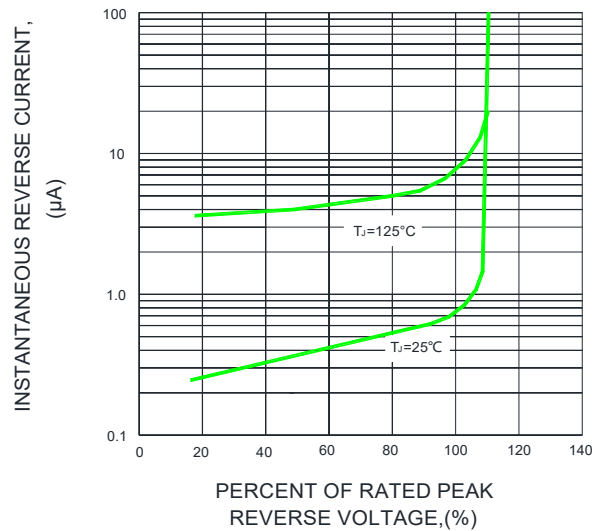
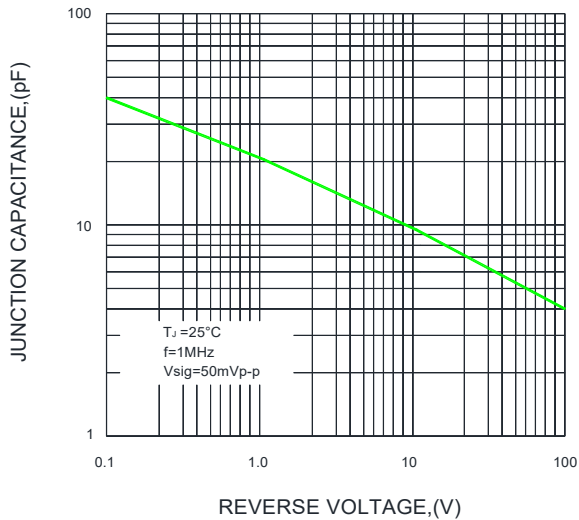


FIG.5-TYPICAL JUNCTION CAPACITANCE

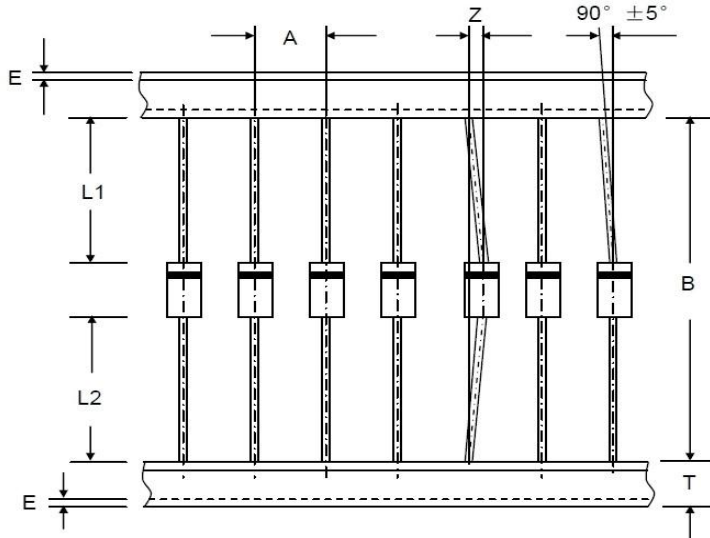




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Axial Lead Taping Specifications for Rectifiers

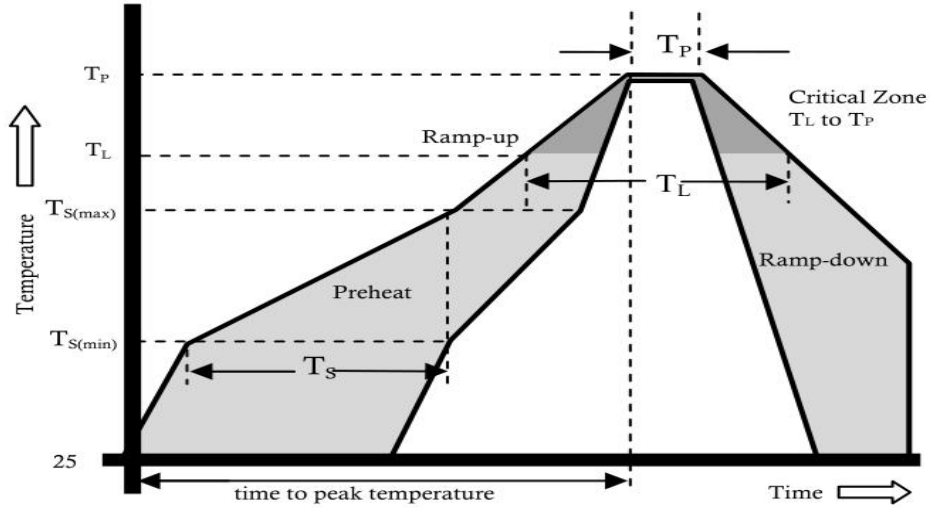


Component Outline	Component Pitch A	Inner Tape Pitch B		Cumulative Tolerance
	±0.5mm	+0.5mm	-0.4mm	
DO-204AL(DO-41)	5.0mm	52.4mm	26.0mm	2.0mm/20pitch

Item	Symbol	Specifications(mm)	Specifications(inch)
Component alignment	Z	1.2 max	0.048 max
Tape width	T	6.0±0.4	0.236±0.016
Exposed adhesive	E	0.8 max	0.032 max
Body eccentricity	IL1-L2I	1.0 max	0.040 max



Reflow Profile



Reflow Condition		Pb-Free Assembly
Pre Heat	Temperature Min.	+150°C
	Temperature Max.	+200°C
	Time(Min to Max)	60-180 secs.
Average ramp up rate(Liquidus Temp(T_L) to peak)		3°C/sec. Max.
$T_S(max)$ to T_L - Ramp-up Rate		3°C/sec. Max.
Reflow	Temperature (T_L)(Liquidus)	+217°C
	Temperature (T_L)	60-150 secs.
Peak Temp (T_P)		+(260+0/-5) °C
Time within 5°C of actual Peak Temp (T_P)		25 secs.
Ramp-down Rate		6°C/sec. Max.
Time 25°C to peak Temp (T_P)		8 min. Max.
Do not exceed		+260°C